

# Product Change Notification / SYST-28NGOB303

# Date:

02-Mar-2023

# **Product Category:**

8-bit Microcontrollers

# PCN Type:

**Document Change** 

# **Notification Subject:**

ERRATA - ATmega640/1280/1281/2560/2561 Silicon Errata and Data Sheet Clarification

# **Affected CPNs:**

SYST-28NGOB303\_Affected\_CPN\_03022023.pdf SYST-28NGOB303\_Affected\_CPN\_03022023.csv

# **Notification Text:**

SYST-28NGOB303

Microchip has released a new Errata for the ATmega640/1280/1281/2560/2561 Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at ATmega640/1280/1281/2560/2561 Silicon Errata and Data Sheet Clarification.

#### Notification Status: Final

Description of Change: The initial release of this document

- Errata content moved from the data sheet and restructured to the new document template
- Data sheet clarifications added:
- Packaging Information: 3.2.1. 100-Ball CBGA
- System Clock and Clock Options: 3.3.1. System Clock and Clock Options
- Output Compare Modulator: 3.4.1. Output Compare Modulator in ATmega640/1280/1281/2560/2561
- Interrupts: 3.5.1. Interrupt Vectors in ATmega640/1280/1281/2560/2561

Impacts to Data Sheet: None

Change Implementation Status: Complete

Date Document Changes Effective: 02 Mar 2023

**NOTE:** Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices::N/A

# **Attachments:**

ATmega640/1280/1281/2560/2561 Silicon Errata and Data Sheet Clarification

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# ATmega640/1280/1281/2560/2 561 Silicon Errata and Data Sheet Clarification

# Silicon Errata and Data Sheet Clarification

# Introduction

The ATmega640/1280/1281/2560/2561 devices you have received conform functionally to the current device data sheet (ww1.microchip.com/downloads/aemDocuments/documents/OTH/ProductDocuments/DataSheets/ ATmega640-1280-1281-2560-2561-Datasheet-DS40002211A.pdf), except for the anomalies described in this document. The errata described in this document will likely be addressed in future revisions of the ATmega640/1280/1281/2560/2561 devices.

### Note:

· This document summarizes all the silicon errata issues from all silicon revisions, previous and current

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	World	wide Sales and Service	)

# 1. Silicon Issue Summary

- Erratum is not applicable.
- X Erratum is applicable.

		Valid for Silicon Revision							
Peripheral	Short Description	ATmeg	a640	ATmega1280/1281		ATmega2560/2561			
		Rev. A ( <u>1</u> )	Rev. B	Rev. A ( <u>1</u> )	Rev. B	Rev. A( <u>1</u> )	Rev. C	Rev. E	Rev. F
Device	2.2.1. Device Does Not Work with VCC Under 2.4V	-	-	-	-	Х	-	-	-
Memory	2.3.1. EEPROM Read From Application Code Does Not Work in Lock Bit Mode 3	-	-	-	-	Х	-	-	-
	2.3.2. IN/OUT Instructions May Be Executed Twice When Stack Is In External RAM	-	-	-	-	Х	-	-	-
Power Management	2.4.1. High Current Consumption In Sleep Mode	Х	Х	Х	Х	-	Х	-	-
Analog to Digital Converter	2.5.4. Inaccurate ADC Conversion in Differential Mode with 200x Gain	Х	Х	Х	-	-	-	-	-
	2.5.1. Incorrect ADC Reading in Differential Mode	-	-	-	-	х	-	-	-
	2.5.2. Internal ADC Reference Has Too Low Value	-	-	-	-	Х	-	-	-
	2.5.3. ADC Differential Input Amplification By 46 dB (200x) is Not Functional	-	-	-	-	-	-	-	Х
Boot Loader	2.6.1. Non-Read-While-Write Area of Flash Not Functional	-	-	-	-	Х	-	-	-

### Note:

1. This revision is the initial release of the silicon.

The following silicon revisions were never released to production:

- ATmega640
  - Rev. C-F
- ATmega1280/1281
  - Rev. C-F
- ATmega2560/2561
  - Rev. B, D

# 2. Silicon Errata Issues

## 2.1 Errata Details

- Erratum is not applicable.
- X Erratum is applicable.

## 2.2 Device

## 2.2.1 Device Does Not Work with V<sub>CC</sub> Under 2.4V

The device does not execute code correctly with V<sub>CC</sub> below 2.4V.

#### Work Around

Do not use the device at  $V_{CC}$  voltages below 2.4V.

#### Affected Silicon Revisions

ATmega2560/2561							
Rev. A Rev. C Rev. E Rev. F							
Х	-	-	-				

## 2.3 Memory

### 2.3.1 EEPROM Read From Application Code Does Not Work in Lock Bit Mode 3

EEPROM read doesn't work from the application code when the memory Lock Bits LB2 and LB1 are programmed to mode 3.

#### Work Around

Do not set Lock Bit Protection Mode 3 when the application code needs to read from EEPROM.

#### Affected Silicon Revisions

ATmega2560/2561							
Rev. A Rev. C Rev. E Rev. F							
Х	-	-	-				

### 2.3.2 IN/OUT Instructions May Be Executed Twice When Stack Is In External RAM

If an IN or an OUT instruction is executed directly before an interrupt occurs, and the stack pointer is located in external RAM, the instruction will be executed twice. In some cases, this will cause a problem, for example:

- If reading SREG, it will appear that the I-flag is cleared
- If writing to the PIN registers, the port will toggle twice
- If reading registers with interrupt flags, the flags will appear to be cleared

#### Work Around

There are two application workarounds; either one of them will avoid the issue:

- Replace IN and OUT with LD/LDS/LDD and ST/STS/STD instructions
- Use internal RAM for the stack pointer

#### Affected Silicon Revisions

ATmega2560/2561							
Rev. A Rev. C Rev. E Rev. F							
X	-	-	-				

## 2.4 **Power Management**

#### 2.4.1 High Current Consumption In Sleep Mode

The current consumption will increase during sleep when executing the SLEEP instruction directly after an SEI instruction if a pending interrupt cannot wake the device from the selected sleep mode.

#### Work Around

Before entering sleep, the interrupts not used to wake the device from sleep mode may be disabled.

#### Affected Silicon Revisions

ATmega640					
Re	и. А	Rev. B			
)	<	)	K		
ATmega1280/1281					
Re	и. А	Rev. B			
)	(	)	K		
ATmega2560/2561					
Rev. A	Rev. C	Rev. E	Rev. F		
-	Х	-	-		

# 2.5 Analog to Digital Converter

#### 2.5.1 Incorrect ADC Reading in Differential Mode

The ADC has high noise in differential mode. It can give up to seven LSBs of error.

#### Work Around

Use only the seven MSBs of the result when using the ADC in differential mode.

#### Affected Silicon Revisions

ATmega2560/2561							
Rev. A Rev. C Rev. E Rev. F							
Х	Х	-	-				

### 2.5.2 Internal ADC Reference Has Too Low Value

The internal ADC reference has a value lower than specified.

#### Work Around

- Use AVCC or external reference
- Measure the actual reference value by applying a known voltage to the ADC when using the internal reference. The result, when doing later conversions, can then be calibrated.

#### Affected Silicon Revisions

ATmega2560/2561						
Rev. A         Rev. C         Rev. E         Rev. F						
X	Х	-	-			

### 2.5.3 ADC Differential Input Amplification By 46 dB (200x) is Not Functional

ADC differential input amplification by 46 dB (200x) is not functional.

#### Work Around

None.

#### Affected Silicon Revisions

ATmega2560/2561							
Rev. A         Rev. C         Rev. E         Rev. F							
-	-	-	Х				

### 2.5.4 Inaccurate ADC Conversion in Differential Mode with 200x Gain

With AVCC < 3.6V, random conversions will be inaccurate. The typical absolute accuracy may reach 64 LSBs.

Work Around Use AVCC ≥ 3.6V.

#### Affected Silicon Revisions

ATmega640					
Rev. A	Rev. B				
X	X				
ATmega1	280/1281				
Rev. A Rev. B					
X	-				

# 2.6 Boot Loader

## 2.6.1 Non-Read-While-Write Area of Flash Not Functional

The Non-Read-While-Write area of the Flash is not working as expected. The problem relates to the device speed when reading the Flash in this area.

### Work Around

- Only use the first 248 KB of the Flash
- If boot functionality is needed, run the code in the Non-Read-While-Write area at a maximum of 1/4<sup>th</sup> of the maximum device frequency at any given voltage by writing the CLKPR register before entering the boot section in the code.

### Affected Silicon Revisions

ATmega2560/2561						
Rev. A Rev. C Rev. E Rev. F						
Х	-	-	-			

# 3. Data Sheet Clarifications

Note the following typographic corrections and clarifications for the latest version of the device data sheet (ww1.microchip.com/downloads/aemDocuments/documents/OTH/ProductDocuments/DataSheets/ ATmega640-1280-1281-2560-2561-Datasheet-DS40002211A.pdf).

Note: Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

# 3.1 Errata Section in Data Sheet is no Longer Valid

A clarification for the Errata section in the device data sheet has been made.

The errata content has been moved to a separate document, ATmega640/1280/1281/2560/2561 Silicon Errata and Data Sheet Clarifications (this document).

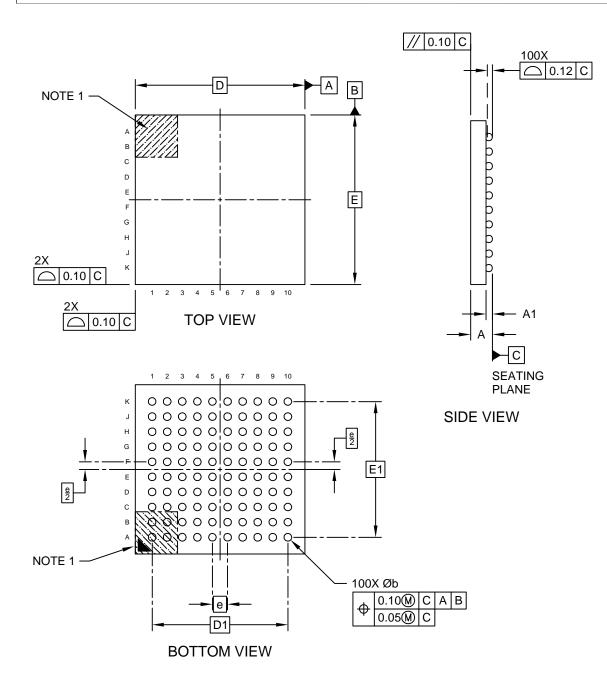
See the Silicon Errata Issues section of this document for the latest errata.

# 3.2 Packaging Information

### 3.2.1 100-Ball CBGA

### 100-Ball Ceramic Ball Grid Array Package (A3B) - 9x9 mm Body [CBGA] Atmel Legacy Global Package Code CPR

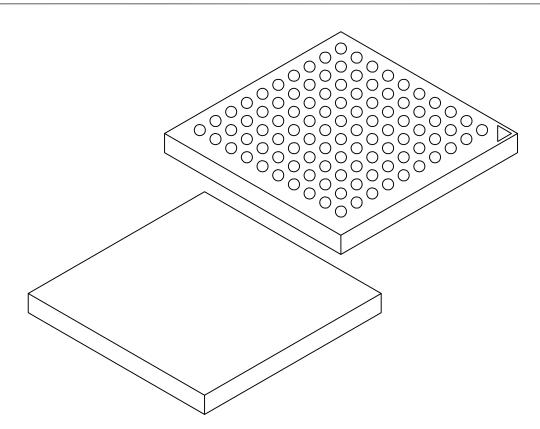
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-21111-A3B Rev A Sheet 1 of 2

## 100-Ball Ceramic Ball Grid Array Package (A3B) - 9x9 mm Body [CBGA] Atmel Legacy Global Package Code CPR

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimensior	Dimension Limits		NOM	MAX	
Number of Terminals	Ν		100		
Pitch	е		0.80 BSC		
Overall Height	А	A 1.10 - 1.2			
Ball Height	A1	0.30	0.35	0.40	
Overall Length	D	9.00 BSC			
Overall Pitch	D1		7.20 BSC		
Overall Width	E	9.00 BSC			
Overall Pitch E1		7.20 BSC			
Terminal Diameter	b	0.35 0.40 0.45			

Notes:

1. Terminal A1 visual index feature may vary, but must be located within the hatched area.

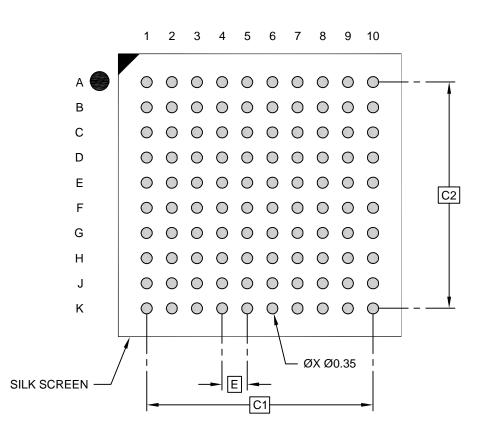
2. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21111-A3B Rev A Sheet 2 of 2

### 100-Ball Ceramic Ball Grid Array Package (A3B) - 9x9 mm Body [CBGA] Atmel Legacy Global Package Code CPR

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



## RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension	Dimension Limits		NOM	MAX
Contact Pitch E		0.58 BSC		
Overall Pitch C1		7.20 BSC		
Contact Pad Spacing	C2	7.20 BSC		
Contact Pad Diameter (X100)	X1			0.35

#### Notes:

- 1. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23111-A3B Rev A

#### Table 3-1. Device and Package Maximum Weight

500

mg

# ATmega640/1280/1281/2560/2561 Silic...

# Data Sheet Clarifications

### Table 3-2. Package Reference

Package Outline Drawing MCHP reference	C04-2111
JESD97 Classification	E3

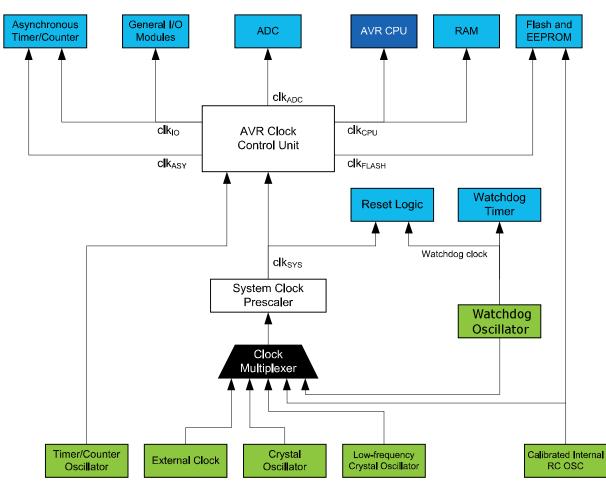
# 3.3 System Clock and Clock Options

#### 3.3.1 System Clock and Clock Options

A clarification for the "Clock Systems and Their Distribution" section has been made.

*Figure "Clock Distribution"* presents the different clock systems in the ATmega640/1280/1281/2560/2561 and their distribution. All of the clocks need not be active at a given time. The clocks to modules not being used can be halted using different sleep modes, as described in the "Power management and Sleep Modes" section, to reduce the power consumption.

Figure "Clock Distribution" helps select an appropriate sleep mode.



#### Figure 3-1. Clock Distribution

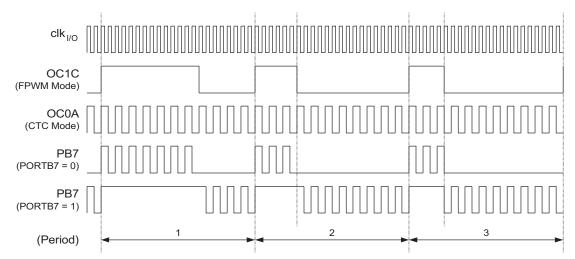
# 3.4 Output Compare Modulator

### 3.4.1 Output Compare Modulator in ATmega640/1280/1281/2560/2561

A clarification for the "Timing example in the Output Compare Modulator" has been made.

The following figure illustrates the modulator in action. In this example, the Timer/Counter1 is set to operate in fast PWM mode (non-inverted), and Timer/Counter0 uses CTC waveform mode with toggle Compare Output mode (COMnx1:0 = 1).

#### Figure 3-2. Output Compare Modulator, Timing Diagram



In this example, **Timer/Counter0** provides the carrier, while the modulating signal is generated by the Output Compare unit C of the Timer/Counter1.

The modulation has reduced the PWM signal (OC1C) resolution. The reduction factor is equal to the number of system clock cycles of one period of the carrier (OC0A). In this example, the resolution is reduced by a factor of two. The figure illustrates the reason for the reduction at the second and third periods of the PB7 output when PORTB7 equals zero. Period 2 high time is one cycle longer than period 3 high time, but the result on the PB7 output is equal in both periods.

# 3.5 Interrupts

### 3.5.1 Interrupt Vectors in ATmega640/1280/1281/2560/2561

A clarification for the source names of the Interrupt vectors has been made to comply with the header file naming convention.

Table 3-3. Reset and Interrupt Vectors in	ATmega640/1280/1281/2560/2561
---	-------------------------------

Vector No	Program Address <sup>(2)</sup>	Source	Interrupts definition	
1	0x0000 <sup>(1)</sup>	RESET	External pin, Power-on Reset, Brown-out Reset, Watchdog Reset and JTAG AVR Reset.	
2	0x0002	INTO	External Interrupt Request 0	
3	0x0004	INT1	External Interrupt Request 1	
4	0x0006	INT2	External Interrupt Request 2	
5	0x0008	INT3	External Interrupt Request 3	
6	0x000A	INT4	External Interrupt Request 4	

# ATmega640/1280/1281/2560/2561 Silic...

# **Data Sheet Clarifications**

contii	nued			
Vector No	Program Address <sup>(2)</sup>	Source	Interrupts definition	
7	0x000C	INT5	External Interrupt Request 5	
8	0x000E	INT6	External Interrupt Request 6	
8	0x0010	INT7	External Interrupt Request 7	
9	0x0012	PCINT0	Pin Change Interrupt Request 0	
10	0x0014	PCINT1	Pin Change Interrupt Request 1	
11	0x0016 <sup>(3)</sup>	PCINT2	Pin Change Interrupt Request 2	
12	0x0018	WDT	Watchdog Time-out Interrupt	
13	0x001A	TIMER2_COMPA	Timer/Counter2 Compare Match A	
14	0x001C	TIMER2_COMPB	Timer/Counter2 Compare Match B	
15	0x001E	TIMER2_OVF	Timer/Counter2 Overflow	
16	0x0020	TIMER1_CAPT	Timer/Counter1 Capture Event	
17	0x0022	TIMER1_COMPA	Timer/Counter1 Compare Match A	
18	0x0024	TIMER1_COMPB	Timer/Counter1 Compare Match B	
19	0x0026	TIMER1_COMPC	Timer/Counter1 Compare Match C	
20	0x0028	TIMER1_OVF	Timer/Counter1 Overflow	
21	0x002A	TIMER0_COMPA	Timer/Counter0 Compare Match A	
22	0x002C	TIMER0_COMPB	Timer/Counter0 Compare Match B	
23	0x002E	TIMER0_OVF	Timer/Counter0 Overflow	
24	0x0030	SPI_STC	SPI Serial Transfer Complete	
25	0x0032	USART0_RX	USART0 Receive complete	
26	0x0034	USART0_UDRE	USART0 Data Register Empty	
27	0x0036	USART0_TX	USART0 Transmit complete	
28	0x0038	ANALOG_COMP	Analog Comparator	
30	0x003A	ADC	ADC Conversion complete	
31	0x003C	EE_READY	EEPROM Ready	
32	0x003E	TIMER3_CAPT	Timer/Counter3 Capture Event	
33	0x0040	TIMER3_COMPA	Timer/Counter3 Compare Match A	
34	0x0042	TIMER3_COMPB	Timer/Counter3 Compare Match B	
35	0x0044	TIMER3_COMPC	Timer/Counter3 Compare Match C	
36	0x0046	TIMER3_OVF	Timer/Counter3 Overflow	
37	0x0048	USART1_RX	USART1 Receive complete	
38	0x004A	USART1_UDRE	USART1 Data Register Empty	
39	0x004C	USART1_TX	USART1 Transmit complete	
40	0x004E	TWI	2-Wire Serial Interface	

# ATmega640/1280/1281/2560/2561 Silic...

# **Data Sheet Clarifications**

continued				
Vector No	Program Address <sup>(2)</sup>	Source	Interrupts definition	
41	0x0050	SPM_READY	PM_READY Store Program Memory Ready	
42	0x0052 <sup>(3)</sup>	TIMER4_CAPT	Timer/Counter4 Capture Event	
43	0x0054	TIMER4_COMPA	Timer/Counter4 Compare Match A	
44	0x0056	TIMER4_COMPB	Timer/Counter4 Compare Match B	
45	0x0058	TIMER4_COMPC	Timer/Counter4 Compare Match C	
46	0x005A	TIMER4_OVF	Timer/Counter4 Overflow	
47	0x005C <sup>(3)</sup>	TIMER5_CAPT	PT Timer/Counter5 Capture Event	
48	0x005E	TIMER5_COMPA	ER5_COMPA Timer/Counter5 Compare Match A	
49	0x0060	TIMER5_COMPB	IMER5_COMPB Timer/Counter5 Compare Match B	
50	0x0062	TIMER5_COMPC	IMER5_COMPC Timer/Counter5 Compare Match C	
51	0x0064	TIMER5_OVF	DVF         Timer/Counter5 Overflow	
52	0x0066 <sup>(3)</sup>	USART2_RX	USART2 Receive complete	
53	0x0068 <sup>(3)</sup>	USART2_UDRE	USART2 Data Register Empty	
54	0x006A <sup>(3)</sup>	USART2_TX	USART2 Transmit complete	
55	0x006C <sup>(3)</sup>	USART3_RX	USART3 Receive complete	
56	0x006E <sup>(3)</sup>	USART3_UDRE	USART3 Data Register Empty	
57	0x0070 <sup>(3)</sup>	USART3_TX	USART3 Transmit complete	

### Notes:

- 1. When the BOOTRST fuse is programmed, the device will jump to the boot loader address at Reset. See "*Boot Loader Support Read-While-Write Self- Programming*".
- 2. When setting the IVSEL bit in MCUCR, Interrupt Vectors will be moved to the start of the boot Flash section. The address of each Interrupt Vector will then be the address in this table added to the start address of the boot Flash section.
- 3. Only available in ATmega640/1280/2560.

# 4. Document Revision History

Note: The document revision is independent of the silicon revision.

# 4.1 Revision History

Doc Rev.	Date	Comments		
В	02/2023	Section "Product Identification System" in the Back Matter is removed		
A	02/2023	<ul> <li>The initial release of this document</li> <li>Errata content moved from the data sheet and restructured to the new document template</li> <li>Data sheet clarifications added: <ul> <li>Packaging Information: 3.2.1. 100-Ball CBGA</li> <li>System Clock and Clock Options: 3.3.1. System Clock and Clock Options</li> <li>Output Compare Modulator: 3.4.1. Output Compare Modulator in ATmega640/1280/1281/2560/2561</li> <li>Interrupts: 3.5.1. Interrupt Vectors in ATmega640/1280/1281/2560/2561</li> </ul> </li> </ul>		

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